

High Current Axial Plastic Rectifier



Case Style P600

FEATURES

- Low forward voltage drop
- Low leakage current, I_R less than 0.1 μA
- High forward current capability
- High forward surge capability
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC


RoHS
COMPLIANT

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes application.

(Note: These devices are not Q101 qualified.)

MECHANICAL DATA

Case: P600, void-free molded epoxy body

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	6.0 A
V_{RRM}	50 V to 800 V
I_{FSM}	400 A
V_F	0.9 V, 0.95 V
I_R	5.0 μA
T_J max.	150 °C

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	GI750	GI751	GI752	GI754	GI756	GI758	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	V
Maximum non-repetitive peak reverse voltage	V_{RSM}	60	120	240	480	720	1200	V
Maximum average forward rectified current at $T_A = 60$ °C, P.C.B. mounting (Fig. 1) $T_L = 60$ °C, 0.125" (3.18 mm) lead length (Fig. 2)	$I_{F(AV)}$	6.0 22						A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	400						A
Operating junction and storage temperature range	T_J, T_{STG}	- 50 to + 150						°C

GI750 thru GI758

Vishay General Semiconductor



ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	GI750	GI751	GI752	GI754	GI756	GI758	UNIT
Maximum instantaneous forward voltage at: 100 A	6.0 A 100 A	V_F			0.90 1.25			0.95 1.30	V
Maximum DC reverse current at rated DC blocking voltage	$T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	I_R			5.0 1.0				μA mA
Typical reverse recovery time	$I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	t_{rr}			2.5				μs
Typical junction capacitance	4.0 V, 1 MHz	C_J			150				pF

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	GI750	GI751	GI752	GI754	GI756	GI758	UNIT
Typical thermal resistance ⁽¹⁾	$R_{\theta JA}$ $R_{\theta JL}$			20				$^\circ\text{C/W}$

Note:

(1) Thermal resistance from junction to ambient and from junction to lead at 0.375" (9.5 mm) lead length, P.C.B. mounted with 1.1" x 1.1" (30 x 30 mm) copper pads

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
GI756-E3/54	2.1	54	800	13" diameter paper tape and reel
GI756-E3/73	2.1	73	300	Ammo pack packaging

RATINGS AND CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

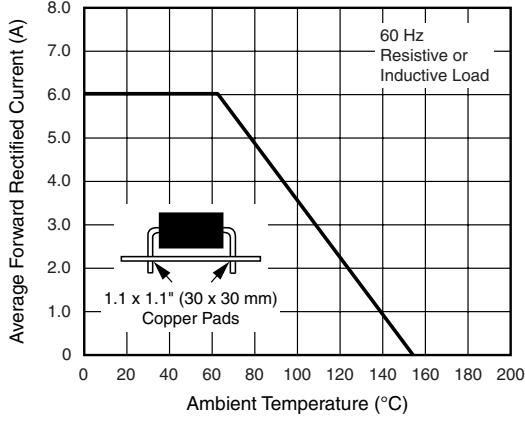


Figure 1. Maximum Forward Current Derating Curve

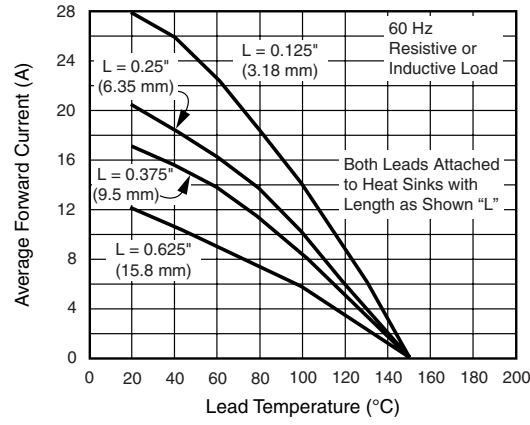


Figure 2. Maximum Forward Current Derating Curve

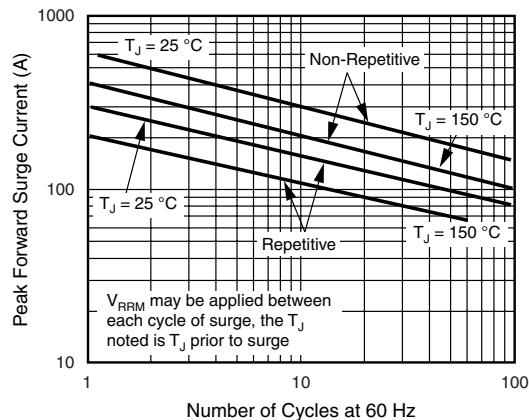


Figure 3. Maximum Peak Forward Surge Current

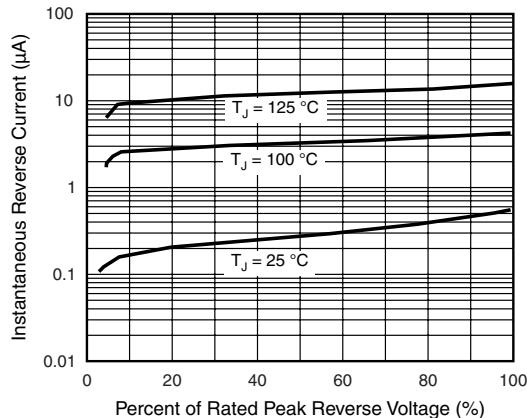


Figure 5. Typical Reverse Characteristics

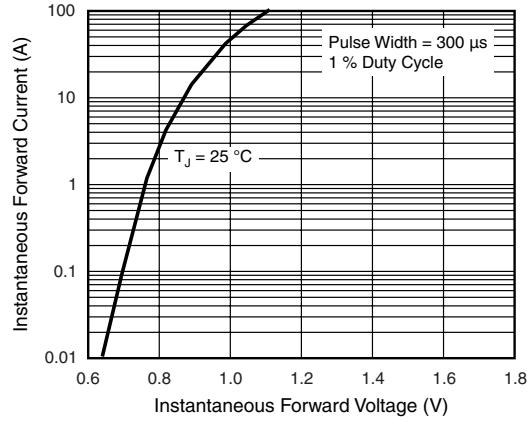


Figure 4. Typical Instantaneous Forward Characteristics

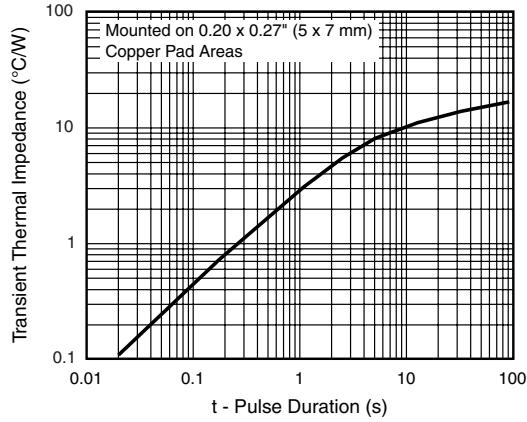


Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

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